

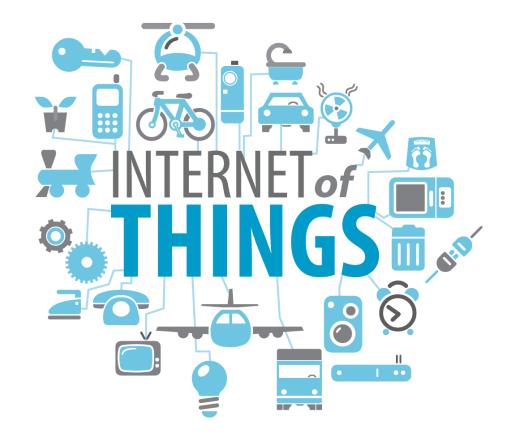
Smart Cities & Industrial IoT: OSIsoft and Qualcomm Collaboration

Presented by Dave Roberts, OSIsoft
Ashok Tipirneni, Qualcomm



Agenda

- Collaboration between Qualcomm and OSIsoft
- Smart Campus Project
- Future Direction
- Q&A



Opening Thoughts

- M2M and Sensor Data is NOT new to Operations Technology
- The PI System has been used over 30 years to integrate data from Industrial Systems and create actionable information
- We're extending these capabilities in multiple directions
 - Data Ingestion (PI Connectors) leveraging IoT technologies to get closer to the edge directly connecting to Assets and Sensors
 - Integrators Enabling Business Intelligence, Predictive Analytics, Machine Learning
 - Geospatial Integrator Visualization in a Geospatially oriented world

The big question...

Instead of getting 100,000 data streams and context from one-plant into PI System... how do you go about getting data from thousands of distributed nodes (IoT) into PI System?

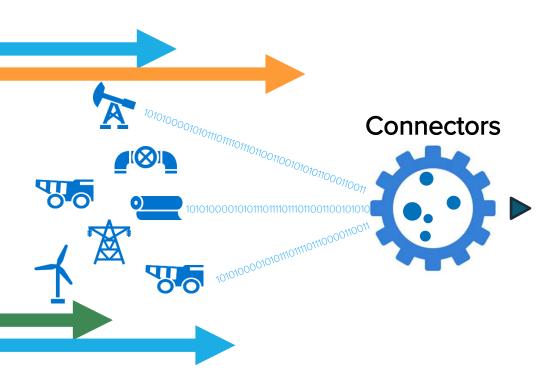
What's new to help answer that question?

- Distributed intelligence with edge processing power resulting in "smarter" sensors and devices.
- New "elastic" technologies that can consume high volumes of data from edge devices (Cloud, Hadoop, ML, Analytics)
- Connectivity and communications standards are becoming cheaper.

What's the Qualcomm & OSIsoft Collaboration About

- Test and Deploy Connectors on Qualcomm enabled Gateways and Devices and Multiple Embedded OS
- 2. Demonstrate highly distributed data acquisition into PI System
- 3. Hybrid Architectural Approach
 - Connecting to Systems (e.g. BACNET to BMS)
 - 2. Connecting to Sensors (e.g. Alljoyn)
 - 3. Connecting to Vendors' Services
- 4. Storing and Presenting Time Series/Context to best-in-class Analytics (Integrators)
- 5. Engage Customers and Partners in Early Adopter Projects

PI Connectors



- Data source is the system of record
- Data collected in terms of assets as defined by the data source
- Assets auto-created in PI AF
- Tags auto-created in PI Data Archive, linked to PI AF Elements
- Events collected and stored in Event Frames
- Easy to configure

See TechCon: Collect your Data in Context Using PI Connectors

Thursday 16:20-16:50



Qualcomm Smart Campus Project



VIDEO



3 Pronged Approach to Smart City/Campus Enablement



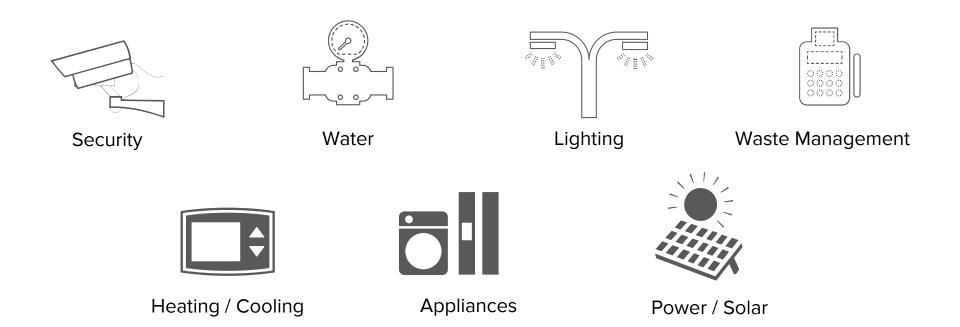






Intelligent Buildings

Connectivity solutions to increase efficiencies, revenues and cost savings



Goals of Smart Campus

A live Smartcities technology showcase & sandbox in San Diego

- Solve key energy management challenges
 - An integrated, BMS agnostic energy management solution
- Showcase Qualcomm Smartcities technologies, Partner Products and solutions.
 - Partner products in live functional environment
- Use case development sandbox for building automation and campus management (and more..)

Creating an Ecosystem of partners



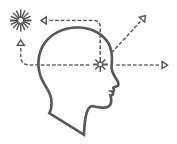
Technology Enablement

- QUALCOMM
- OSIsoft



New Product Development

- Digi
- Itron



Systems Integrators

- CH2M
- Schneider Electric

Qualcomm Technologies in Smart Campus



Infrastructure tools



Sensor Monitoring



Machine Learning



Computer Vision
Interactivity





(Asset Management Gateway)







At the edge product:

- MDM/8Xxx/7xxx Integrated connectivity modules
- Alljoyn (open) interoperability solutions
- Sensor advancements:
 - Low power image recognition tech
 - Always On Proximity sensors
 - Image processing

At the Gateway:

- IPQ: w/ Streamboost
- DSRC interoperability solutions
- Asset management IoT gateway
- Object recognition and computer vision

At the Interconnect

- 3G/4G connectivity technologies
- LTE- U: Unlicensed band
- LTE- **B**: Broadcast
- LTE- D : Direct

At the Data:

- Machine Learning Algorithms
- Pattern recognition and predictive analytics



Qualcomm Solutions and Technologies

Apps & Ecosystem













Software Frameworks





Qualcomm[®] Vuforia™

Lumicast

Qualcomm

Boards/Reference Desig Prapdragon Based Dev Board

MPQ Based Dev Board

Gobi Based **Dev Board**

Wi-Fi Based **Dev Board**

Processors/Chipsets







Core Technologies







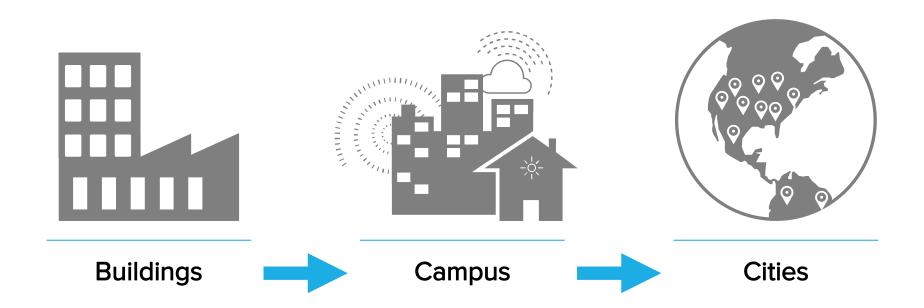








Transition from Intelligent Buildings



Smart Cities Market Verticals



Smart Building

- Connectivity
- Integrated Service



Smart Transportation

- Smart Mobility
- Smart Charging
- Smart Traffic
- Smart Parking



Smart Infrastructure

- Smart Water
- Smart Lighting
- Smart Waste Management



Smart Energy

- Energy Efficiency
- Reduced Emissions
- Smart meters

Intelligent connectivity within and across City Verticals is key

Enabling Wireless Connectivity





DragonBoard 410c

- Windows 10 support (+Android & Linux)
- Quad-core ARM® Cortex™ A53 at up to 1.2 GHz per core
- 64-Bit capable
- Memory LPDDR2/3 533MHz Single-channel 32-bit (4.2GBps) non-POP/ eMMC 4.51 SD 3.0 (UHS-I)
- Connectivity integrated 802.11 b/g/n, BT/FM
- Power Management + Audio Codec

Asset Management Gateway

- Embedded operating system (Android-based)
- 3G, Wi-Fi, Bluetooth, GPS air interfaces
- 2 x USB plug-ins for ZigBee or other short-range radios
- External SMA connectors for all radio antennas
- Ethernet ports for MODBUS/TCP
- CANbus interface for DeviceNET and BACNet
- 2 external USB ports
- Analog & Digital I/O (expandable)
- 10 36 Volt DC power



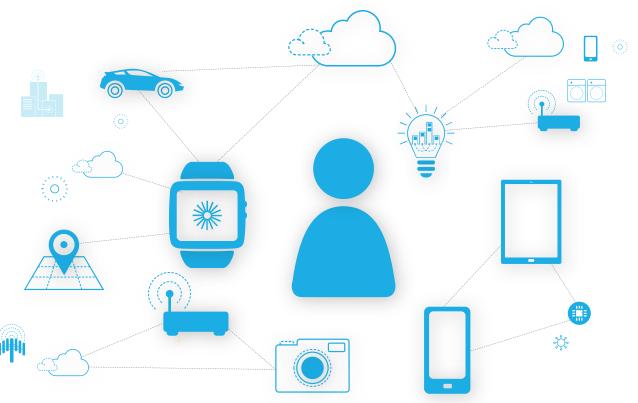
AP148 | IPQ Reference Bo

- Dual core 1.4GHz Krait with ~10.000 DMIPS
- Dual core NSS @ 740MHz processes 5Gbps traffic
- Quad core of Crypto5 security engine
- Highest DMIPS per Watt: ~4.3 DMIPS/Watt
- Universal interfaces: USB 3.0, SATA 3.0, PCle 2.0
- Line rate NAT Ethernet Switch
- ~12.5W can be supported by 802.3af

Qualcomm Krait is a product of Qualcomm Technologies, Inc. Qualcomm Internet Processor is a product of Qualcomm Atheros, Inc.



Enabling the Intelligent Edge



Edge

end devices + access nodes



Caution – Futureware...

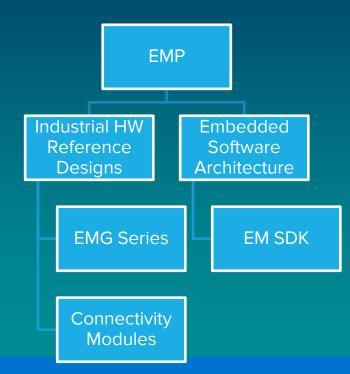
Qualcomm® Edge Management Platform (EMP)

Edge Management Gateway Reference Designs and Software Solutions for the Industrial Internet

Overview

Qualcomm's Edge Management Platform or EMP, offers a series of hardware reference designs and software capabilities to address the connectivity, edge intelligence and interconnect (backhaul) requirements for the rapidly expanding Industrial Internet space.

- Connectivity: Short-medium range, proximate connectivity solutions and enablers such as 802.11x, 802.15.4, 802.15.1, DSRC, LTE-D
- Edge Intelligence Platforms: Application development for edge of network platforms— CPU, AP, GPU, GPS, RTOS/HLOS, Core Services
- Interconnect: Reliable backhaul connectivity via 3G/4G modems, Wi-Fi & Small Cells

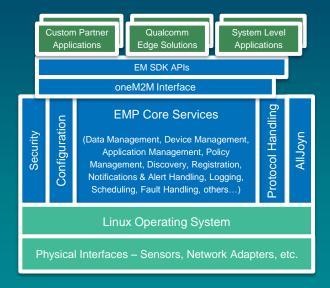




Qualcomm® Edge Management Software and Services

An Embedded Edge Platform and Software Development Kit for the Industrial Internet

- Embedded Software Platform for Industrial Gateway Devices
- Long Term Supported Linux Distro Optimized for Embedded Space
- Software Architecture Implements A Common Services Layer Approach
- Core SDK Objectives:
 - Enable Sensor Edge Connectivity
 - Simplify and Reduce Complexity
 - Enhance Interoperability Among Disparate Sensor Networks
 - Promote Security and Data Integrity
- Initial SDK Release Planned for Q1 2016



Edge Management Software & Services Architecture







Learn More: Qualcomm.com/smart-cities



Summary

- PI Connectors on Gateways are a good start...
- OSIsoft and Qualcomm are collaborating to solve really big IoT challenges:
 - Supporting multiple operating systems at the edge...
 - Provision, Manage and Maintain at the edge...
 - Bi-directionality...
 - Security...
 - Enabling Ecospheres...
- Seeking Early Adopter engagements with Customers & Partners

Questions

Please wait for the microphone before asking your questions



Please don't forget to...

Complete the Online Survey for this session



http://eventmobi.com/emeauc15



감사합니다

Merci

谢谢

Danke

Gracias

Thank You

ありがとう

Спасибо

Obrigado